

July 1996 Revised May 2005

74ABT16541

16-Bit Buffer/Line Driver with 3-STATE Outputs

General Description

The ABT16541 contains sixteen non-inverting buffers with 3-STATE outputs designed to be employed as a memory and address driver, clock driver, or bus oriented transmitter/receiver. The device is byte controlled. Individual 3-STATE control inputs can be shorted together for 8-bit or 16-bit operation.

Features

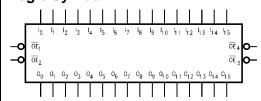
- Separate control logic for each nibble
- 16-bit version of the ABT541
- Outputs sink capability of 64 mA, source capability of 32 mA
- Guaranteed simultaneous switching noise level and dynamic threshold performance
- Guaranteed latchup protection
- High impedance glitch free bus loading during entire power up and power down cycle
- Non-destructive hot insertion capability

Ordering Code:

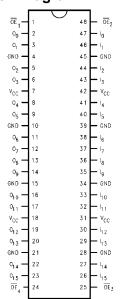
Order Number	Package Number	Package Description
74ABT16541CSSC	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74ABT16541CMTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Device also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Pin Descriptions

Pin Names	Description					
ŌE n	Output Enable Inputs (Active Low)					
I ₀ -I ₁₅	Inputs					
O ₀ -O ₁₅	Outputs					

Truth Tables

	Inputs					
OE 1	OE 2	O ₀ -O ₇				
L	L	L	L			
L	L	Н	Н			
Н	X	Χ	Z			
Х	Н	Χ	Z			

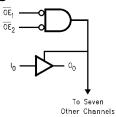
	Inputs				
OE 4	OE ₃	OE ₃ I ₈ -I ₁₅			
L	L	L	L		
L	L	Н	Н		
Н	Χ	Χ	Z		
Х	Н	Χ	Z		

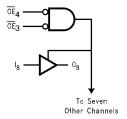
- H = HIGH Voltage Level
- L = LOW Voltage Level
- X = Immaterial
 Z = High Impedance

Functional Description

The ABT16541 contains sixteen non-inverting buffers with 3-STATE outputs. The device is byte (8 bits) controlled with each byte functioning identically, but independent of the other. The control pins can be shorted together to obtain full 16-bit operation.

Logic Diagrams





Absolute Maximum Ratings(Note 1)

 $\begin{array}{ll} \mbox{Storage Temperature} & -65\mbox{°C to } +150\mbox{°C} \\ \mbox{Ambient Temperature under Bias} & -55\mbox{°C to } +125\mbox{°C} \\ \end{array}$

Junction Temperature under Bias -55°C to +150°C

 V_{CC} Pin Potential to Ground Pin -0.5V to +7.0VInput Voltage (Note 2) -0.5V to +7.0V

Input Current (Note 2) –30 mA to +5.0 mA

Voltage Applied to Any Output

in the Disabled or

Power-Off State -0.5V to 5.5V in the HIGH State -0.5V to V_{CC}

Current Applied to Output

in LOW State (Max) $\mbox{twice the rated $I_{\rm OL}$ (mA)$} \\ \mbox{DC Latchup Source Current} \\ \mbox{-500 mA}$

Over Voltage Latchup (I/O) 10V

Recommended Operating Conditions

Free Air Ambient Temperature -40°C to +85°C Supply Voltage +4.5V to +5.5V

Minimum Input Edge Rate ($\Delta V/\Delta t$)

Data Input 50 mV/ns
Enable Input 20 mV/ns

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation

under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Para	meter	Min	Тур	Max	Units	V _{CC}	Conditions
V _{IH}	Input HIGH Voltage		2.0			V		Recognized HIGH Signal
V _{IL}	Input LOW Voltage				0.8	V		Recognized LOW Signal
V _{CD}	Input Clamp Diode Volta	ige			-1.2	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH		2.5			V	Min	I _{OH} = -3 mA
	Voltage		2.0			V	Min	I _{OH} = -32 mA
V _{OL}	Output LOW Voltage				0.55	V	Min	I _{OL} = 64 mA
I _{IH}	Input HIGH Current				1	_	Max	V _{IN} = 2.7V (Note 3)
					1	μА	IVIAX	$V_{IN} = V_{CC}$
I _{BVI}	Input HIGH Current				7	μА	Max	V _{IN} = 7.0V
	Breakdown Test							
I _{IL}	Input LOW Current				-1		Max	V _{IN} = 0.5V (Note 3)
					-1	μА	IVIAX	$V_{IN} = 0.0V$
V _{ID}	Input Leakage Test		4.75			V	0.0	I _{ID} = 1.9 μA
								All Other Pins Grounded
I _{OZH}	Output Leakage Curren	t			10	μА	0-5.5V	$V_{OUT} = 2.7V; \overline{OE}_n = 2.0V$
I _{OZL}	Output Leakage Curren	ţ			-10	μА	0-5.5V	$V_{OUT} = 0.5V; \overline{OE}_n = 2.0V$
Ios	Output Short-Circuit Cu	rent	-100		-275	mA	Max	V _{OUT} = 0.0V
I _{CEX}	Output HIGH Leakage (Current			50	μА	Max	V _{OUT} = V _{CC}
I _{ZZ}	Bus Drainage Test				100	μА	0.0	V _{OUT} = 5.5V
								All Other Pins GND
I _{CCH}	Power Supply Current				100	μА	Max	All Outputs HIGH
I _{CCL}	Power Supply Current				60	mA	Max	All Outputs LOW
I _{CCZ}	Power Supply Current				100	μА	Max	OE _n = V _{CC}
								All Others at V _{CC} or GND
I _{CCT}	Additional I _{CC} /Input	Outputs Enabled			2.5	mA		V _I = V _{CC} - 2.1V
		Outputs 3-STATE			2.5	mA	Max	Enable Input V _I = V _{CC} - 2.1V
		Outputs 3-STATE			50	μА		Data Input V _I = V _{CC} - 2.1V
								All Others at V _{CC} or GND
I _{CCD}	Dynamic I _{CC}	No Load				mA/		Outputs Open, \overline{OE}_n = GND
	(Note 3)				0.1	MHz	Max	One Bit Toggling,
								50% Duty Cycle
V _{OLP}	Quiet Output Maximum	Dynamic V _{OL}		0.4	0.7	V	5.0	T _A = 25°C (Note 4)
V _{OLV}	Quiet Output Minimum I	Dynamic V _{OL}	-1.3	-1.0		V	5.0	T _A = 25°C (Note 4)
V _{OHV}	Minimum HIGH Level D	ynamic Output Voltage	2.7	3.0		V	5.0	T _A = 25°C (Note 6)
V _{IHD}	Minimum HIGH Level D	ynamic Input Voltage	2.0	1.4		V	5.0	T _A = 25°C (Note 5)

DC Electrical Characteristics (Continued)

Symbol	Parameter	Min	Тур	Max	Units	V _{CC}	Conditions
V _{ILD}	Maximum LOW Level Dynamic Input Voltage		1.2	0.8	V	5.0	T _A = 25°C (Note 5)

Note 3: Guaranteed but not tested.

Note 4: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. One output at LOW. Guaranteed, but not tested.

Note 5: Max number of data inputs (n) switching. n-1 inputs switching 0V to 3V. Input-under-test switching: 3V to threshold (V_{ILD}), 0V to threshold (V_{IHD}). Guaranteed, but not tested.

Note 6: Max number of outputs defined as (n). n - 1 data inputs are driven 0V to 3V. One output HIGH. Guaranteed, but not tested.

AC Electrical Characteristics

Symbol	Parameter		T_A =+25°C V_{CC} =+5V C_L = 50 pF			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V} -5.5\text{V}$ $C_L = 50 \text{ pF}$	
		Min	Тур	Max	Min	Max	
t _{PLH}	Propagation	1.0	2.3	3.4	1.0	3.4	20
t _{PHL}	Delay Data to Outputs	1.0	2.7	3.9	1.0	3.9	ns
t _{PZH}	Output Enable	1.5	3.5	5.2	1.5	5.2	
t _{PZL}	Time	1.5	3.5	6.0	1.5	6.0	ns
t _{PHZ}	Output Disable	1.0	4.2	5.1	1.0	5.1	
t _{PLZ}	Time	1.0	3.2	5.1	1.0	5.1	ns

Extended AC Electrical Characteristics

Symbol	Parameter	Vo	40°C to +85° _{CC} = 4.5V-5. C _L = 50 pF utputs Swite (Note 7)	5V	V _{CC} = 4 C _L = 2	C to +85°C .5V-5.5V 250 pF Switching te 8)	V _{CC} = 4. C _L = 2	C to +85°C 5V-5.5V 250 pF s Switching te 9)	Units
		Min	Тур	Max	Min	Max	Min	Max	
f _{TOGGLE}	Maximum Toggle Frequency		100						MHz
t _{PLH}	Propagation Delay	1.5		5.0	1.5	6.0	2.5	8.0	no
t _{PHL}	Data to Outputs	1.5		5.3	1.5	6.0	2.5	8.0	ns
t _{PZH}	Output Enable	1.5		6.5	2.5	7.8	2.5	9.5	no
t_{PZL}	Time	1.5		6.5	2.5	7.8	2.5	8.5	ns
t _{PHZ}	Output Disable	1.0		6.7	(Not	e 10)	(Not	e 10)	ns
t_{PLZ}	Time	1.0		6.7					

Note 7: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).

Note 8: This specification is guaranteed but not tested. The limits represent propagation delay with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load. This specification pertains to single output switching only.

Note 9: This specification is guaranteed but not tested. The limits represent propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.) with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.

Note 10: The 3-STATE delay times are dominated by the RC network (500Ω, 250 pF) on the output and have been excluded from the datasheet.

Skew

Symbol	Parameter	T _A = -40°C to +85°C V _{CC} = 4.5V-5.5V C _L = 50 pF 16 Outputs Switching (Note 11) Max	T _A = -40°C to +85°C V _{CC} = 4.5V-5.5V C _L = 250 pF 16 Outputs Switching (Note 12) Max	Units
t _{OSHL} (Note 13)	Pin to Pin Skew HL Transitions	1.0	1.5	ns
t _{OSLH} (Note 13)	Pin to Pin Skew LH Transitions	1.0	1.5	ns
t _{PS} (Note 14)	Duty Cycle LH–HL Skew	1.5	1.5	ns
t _{OST} (Note 13)	Pin to Pin Skew LH/HL Transitions	1.7	2.0	ns
t _{PV} (Note 15)	Device to Device Skew LH/HL Transitions	2.0	2.5	ns

Note 11: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.)

Note 12: These specifications guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.

Note 13: Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH-to-LOW (t_{OSHL}), LOW-to-HIGH (t_{OSLH}), or any combination switching LOW-to-HIGH and/or HIGH-to-LOW (t_{OST}). The specification is guaranteed but not tested.

Note 14: This describes the difference between the delay of the LOW-to-HIGH and the HIGH-to-LOW transition on the same pin. It is measured across all the outputs (drivers) on the same chip, the worst (largest delta) number is the guaranteed specification. This specification is guaranteed but not tested.

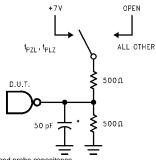
Note 15: Propagation delay variation for a given set of conditions (i.e., temperature and V_{CC}) from device to device. This specification is guaranteed but not tested

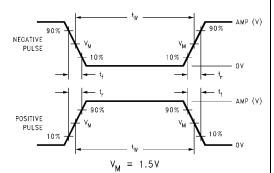
Capacitance

Symbol	Parameter	Тур	Units	Conditions T _A = 25°C
C _{IN}	Input Capacitance	5.0	pF	V _{CC} = 5.0V
COUT (Note 16)	Output Capacitance	9.0	pF	$V_{CC} = 5.0V$

Note 16: C_{OUT} is measured at frequency f = 1 MHz; per MIL STD-883, Method 3012.

AC Loading





* Includes jig and probe capacitance

FIGURE 1. Standard AC Test Load

FIGURE 2. Test Input Pulse Requirements

Amplitude	Rep Rate	t _W	t _r	t _f
3.0V	1 MHz	500 ns	2.5 ns	2.5 ns

FIGURE 3. Test Input Signal Requirements

AC Waveforms

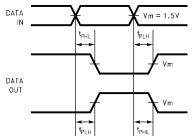


FIGURE 4. Propagation Delay Waveforms for Inverting and Non-Inverting Functions

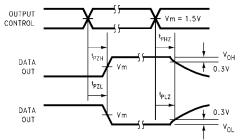


FIGURE 6. 3-STATE Output HIGH and LOW Enable and Disable Times

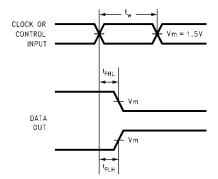


FIGURE 5. Propagation Delay, Pulse Width Waveforms

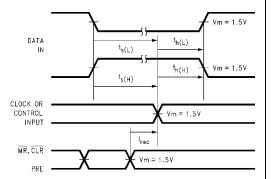
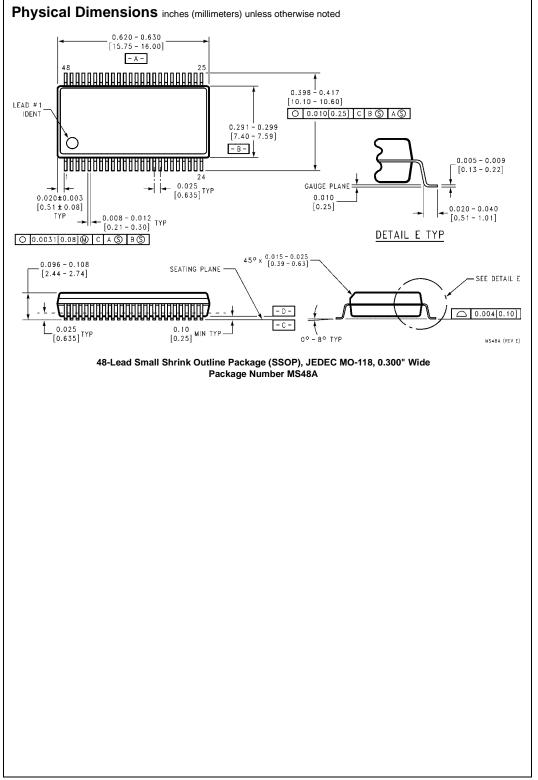


FIGURE 7. Setup Time, Hold Time and Recovery Time Waveforms



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 12.50±0.10 0.40 TYP -B-10±0,10 89 9.30 B.10 50. O.2 C B A ALL LEAD TIPS PIN #1 IDENT LAND PATTERN RECOMMENDATION O.1 C SEE DETAIL A 0.90+0.15 0.09-0.20 0.10±0.05 0.50 0.17-0.27 ♦ 0.13\(\old{\text{0}} \) A B\(\old{\text{S}} \) C\(\old{\text{S}} \) 12.00' TOP & BOTTOM DIMENSIONS ARE IN MILLIMETERS GAGE PLANE 0.25 NOTES A. CONFORMS TO JEDEC REGISTRATION MC-153, VARIATION ED, DATE 4/97. B. DIMENSIONS ARE IN MILLIMETERS. SEATING PLANE 0.60±0.10 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS. D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982. DETAIL A MTD48REVC

48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD48

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